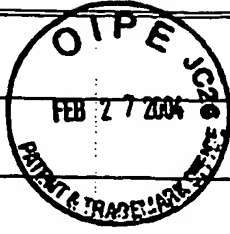


FORM PTO 1449 (modified)  U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE  LIST OF REFERENCES CITED BY APPLICANT(S) (Use several sheets if necessary)  Date Submitted to PTO: February 26, 2004		ATTY DOCKET NO. <b>PD-203021</b>	APPLICATION NO. <b>10/613,877</b>		
APPLICANT <b>M. EROZ et al.</b>		FILING DATE <b>July 3, 2003</b>		GROUP <b>2631</b>	

U.S. PATENT DOCUMENTS						
*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
H.V.	US 2003/0179768	September 25, 2003	Lusky et al.	370	437	
H.V.	US 2003/0152158	August 14, 2003	Torres et al.	375	265	
H.V.	US 2002/0136317	September 26, 2002	Oelcer et al.	375	261	

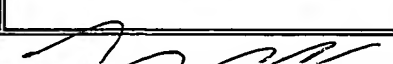
  

FOREIGN PATENT DOCUMENTS						
	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES/NO/OR ABSTRACT
H.V.	EP 0 998 087 A1	May 3, 2000	EPO	H04L	27/34	
H.V.	WO 02/056559 A1	July 18, 2002	PCT	H04L	27/34	

OTHER DOCUMENT(S) (Including Author, Title, Data, Pertinent Pages, etc.)	
H.V.	Flarion Technologies, Inc., "Vector-LDPC Coding Solution Data Sheet", www.flarion.com, 2003
H.V.	H. Tullberg and P. Siegel, "Bit-Interleaved Coded Modulation for Delay-Constrained Mobile Communication Channels". Proceedings, IEEE Vehicular Technology Conference, VTC 2000, pp. 2212-2216, May 15-18, 2000
H.V.	S. Le Goff, "Channel Capacity of Bit-Interleaved Coded Modulation Schemes Using 8-ary Signal Constellations", Electronics Letters, IEE Stevenage, GB, Vol. 38, No. 4, pp. 187-189, February 14, 2002
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H.V.	X. Li et al., "Trellis-Coded Modulation With Bit Interleaving and Iterative Decoding", IEEE Journal on Selected Areas in Communications, Vol. 17, No. 4, pp. 715-724, April 1999

EXAMINER	DATE CONSIDERED
	<b>8/30/04</b>

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.